

**Silicon Bridge Rectifiers****Features**

- Low forward voltage drop
- Electrically isolated base -2000 Volts
- High surge forward current capability
- Materials used carries U/L recognition

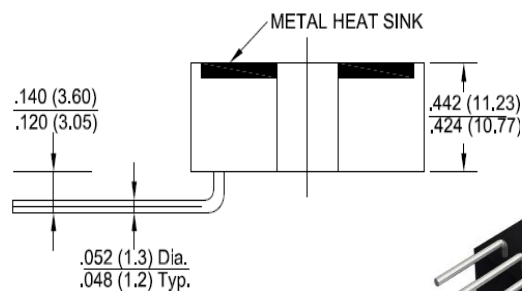
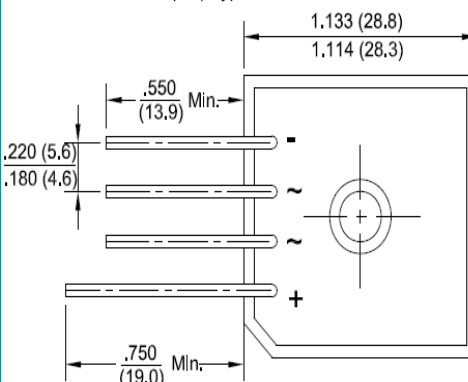
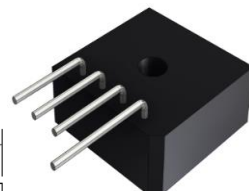
**Mechanical Data**

- Polarity: Symbol Marked on body
- Mounting position: Any

Note: Products with logo  or  are made by HY Electronic (Cayman) Limited.

**Applications**

- General purpose use in AC/DC bridge full wave rectification, for power supply, industrial automation applications, etc.

**Reverse Voltage - 50 to 1000 Volts****Forward Current - 50 Amperes****BR-L****RoHS  
COMPLIANT**

Package Outline Dimensions in Inches (Millimeters)

**Maximum Ratings and Electrical Characteristics**

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristics	Symbol	BR 5005L	BR 501L	BR 502L	BR 504L	BR 506L	BR 508L	BR 5010L	Unit
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum Average Forward Rectified Current @ $T_C=55^\circ\text{C}$	$I_{(AV)}$	50							A
Peak Forward Surge Current, 8.3ms Single Half Sine-Wave, Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	500							A
$I^2t$ Rating for Fusing ( $t < 8.3\text{ms}$ )	$I^2t$	1037.5							$\text{A}^2\text{s}$
Peak Forward Voltage per Diode at 25A DC	$V_F$	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage per Diode @ $T_J=25^\circ\text{C}$	$I_R$	10							$\mu\text{A}$
Operating Junction Temperature Range	$T_J$	-55 to +150							$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 to +150							$^\circ\text{C}$



Fig. 1 - Forward Current Derating Curve

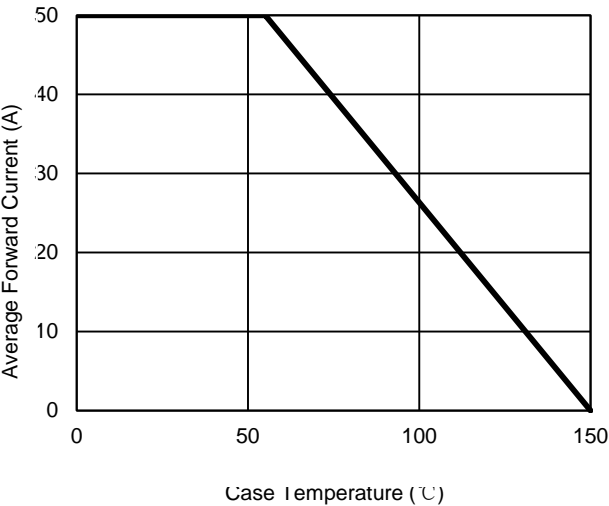


Fig. 2 - Maximum Non-Repetitive Surge Current

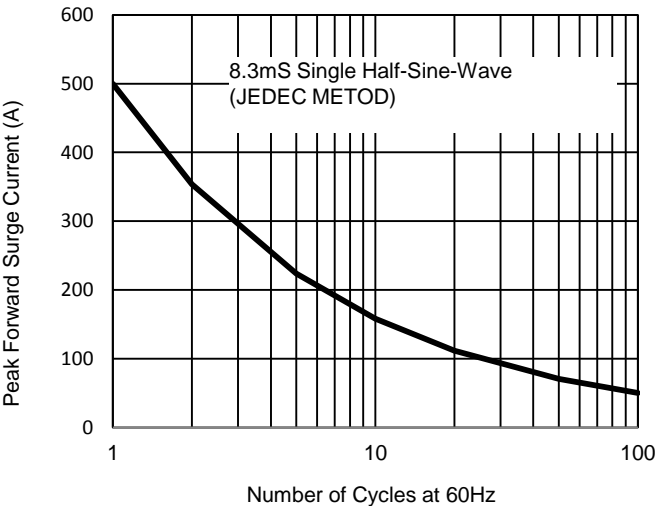


Fig. 3 - Typical Reverse Characteristics

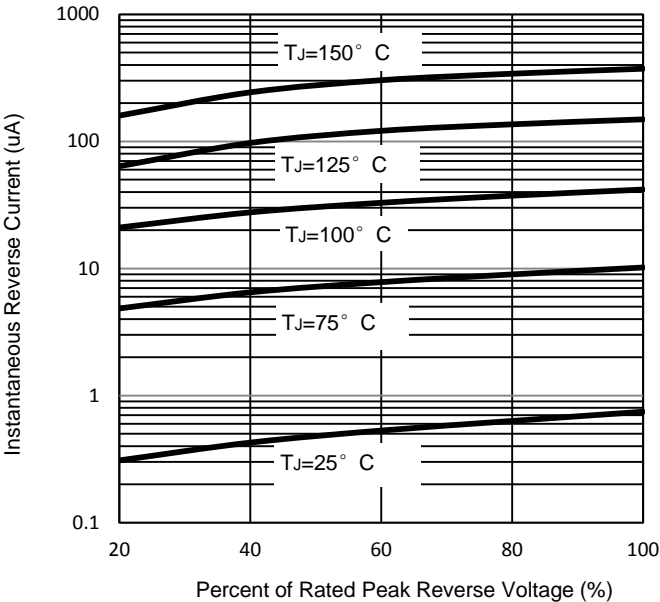
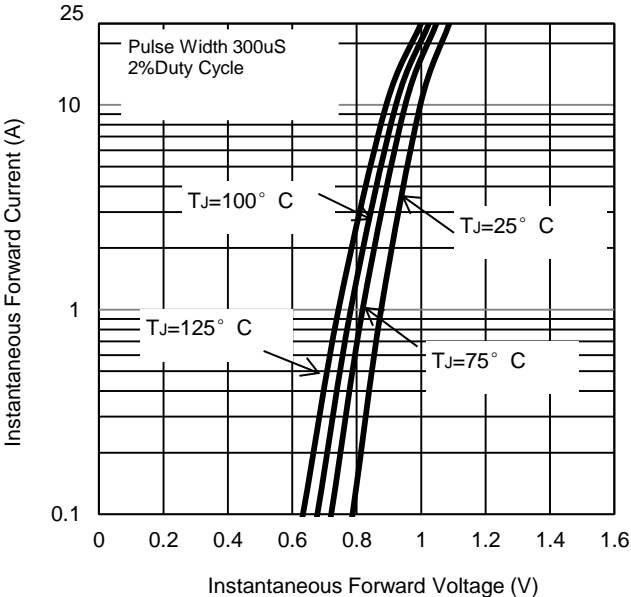


Fig. 4 - Typical Forward Characteristics



The curve above is for reference only.



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